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FQT5P10

P-Channel QFET® MOSFET

-100 V, -1.0 A, 1.05 Ω

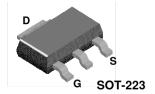
Description

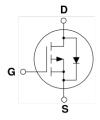
This P-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor®'s proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.



Features

- -1.0 A, -100 V, $R_{DS(on)}$ =1.05 $\Omega(Max.)$ @ V_{GS} =-10 V, I_D =-0.5 A
- Low Gate Charge (Typ. 6.3 nC)
- Low Crss (Typ. 18 pF)
- · 100% Avalanche Tested





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQT5P10	Unit	
V _{DSS}	Drain-Source Voltage		-100	V	
I _D	Drain Current - Continuous (T _C = 25°	C)	-1.0	А	
	- Continuous (T _C = 70°C)		-0.8	А	
I _{DM}	Drain Current - Pulsed	(Note 1)	-4.0	А	
V _{GSS}	Gate-Source Voltage		±30	V	
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	55	mJ	
I _{AR}	Avalanche Current	(Note 1)	-1.0	А	
E _{AR}	Repetitive Avalanche Energy	(Note 1)	0.2	mJ	
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	-6.0	V/ns	
P _D	Power Dissipation (T _C = 25°C)		2.0	W	
	- Derate above 25°C		0.016	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C	
T _L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C	

Thermal Characteristics

Symbol	Parameter	Тур	Max	Unit
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		62.5	°C/W

^{*} When mounted on the minimum pad size recommended (PCB Mount)

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
Off Cha	racteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$		-100			V
ΔB _{VDSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = -250 μA, Referenced to 25°C			-0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -100 V, V _{GS} = 0 V	= -100 V, V _{GS} = 0 V			-1	μΑ
		V _{DS} = -80 V, T _C = 125°C				-10	μΑ
I _{GSSF}	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V				-100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	V _{GS} = 30 V, V _{DS} = 0 V				100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$		-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	V _{GS} = -10 V, I _D = -0.5 A			0.82	1.05	Ω
9 _{FS}	Forward Transconductance	V _{DS} = -40 V, I _D = -0.5 A	(Note 4)		1.4		S
C _{iss}	Input Capacitance Output Capacitance	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz			190 70	250 90	pF pF
C _{rss}	Reverse Transfer Capacitance				18	25	pF
Switchi	ng Characteristics						
t _{d(on)}	Turn-On Delay Time				9	30	ns
t _r	Turn-On Rise Time	$V_{DD} = -50 \text{ V}, I_{D} = -4.5 \text{ A},$ $R_{G} = 25 \Omega$ (Note 4, 5)			70	150	ns
t _{d(off)}	Turn-Off Delay Time				12	35	ns
t _f	Turn-Off Fall Time				30	70	ns
Q _g	Total Gate Charge	V _{DS} = -80 V, I _D = -4.5 A, V _{GS} = -10 V			6.3	8.2	nC
Q _{gs}	Gate-Source Charge				1.7		nC
Q _{gd}	Gate-Drain Charge	4	(Note 4, 5)		3.0		nC
	ource Diode Characteristics a	nd Maximum Ratings					
l _S	Source Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current					-1.0	Α
I _{SM}	Maximum Pulsed Drain-Source Diode Forward Current				-4.0	Α	
V _{SD}	Drain-Source Diode Forward Voltage	V _{GS} = 0 V, I _S = -1.0 A				-4.0	V
trr	Reverse Recovery Time	$V_{GS} = 0 \text{ V}, I_{S} = -4.5 \text{ A},$			85		ns
Qrr	Reverse Recovery Charge	$dI_{\rm F}$ / $dt = 100 \text{A/}\mu\text{s}$	(Note 4)		0.27		μC

- **Notes:**1. Repetitive Rating : Pulse width limited by maximum junction temperature 2. L = 83mH, I_{AS} = -1.0A, V_{DD} = -25V, R_G = 25 Ω , Starting T_J = 25°C 3. I_{SD} \leq -4.5A, dil/dt \leq 300A/µs, V_{DD} \leq BV_{DSS}, Starting T_J = 25°C 4. Pulse Test : Pulse width \leq 300µs, Duty cycle \leq 2% 5. Essentially independent of operating temperature

Typical Characteristics

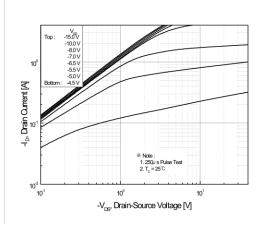


Figure 1. On-Region Characteristics

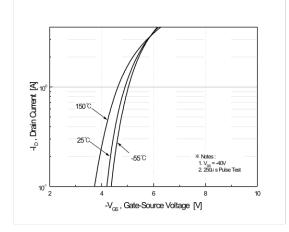


Figure 2. Transfer Characteristics

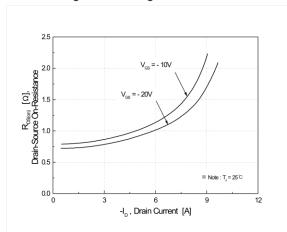


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

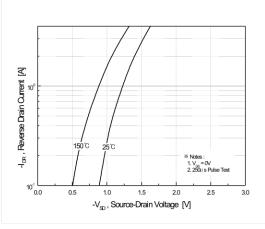


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

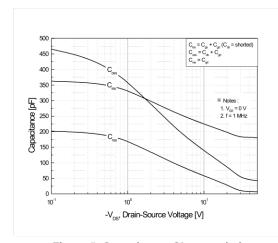


Figure 5. Capacitance Characteristics

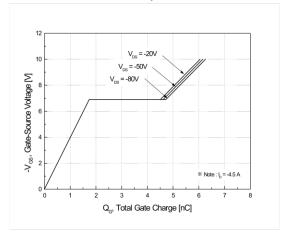
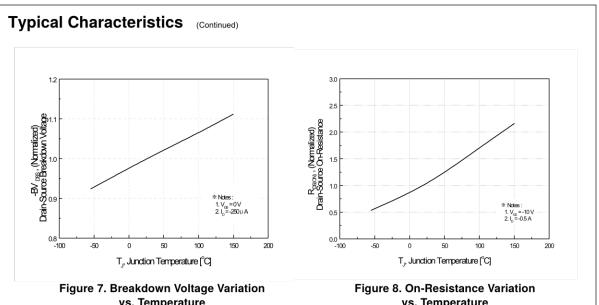
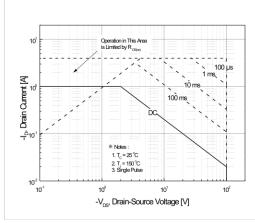


Figure 6. Gate Charge Characteristics



vs. Temperature

vs. Temperature



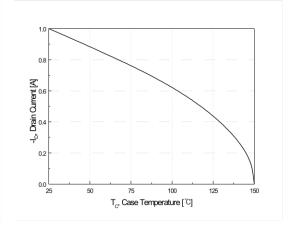


Figure 9. Maximum Safe Operating Area

Figure 10. Maximum Drain Current vs. Case Temperature

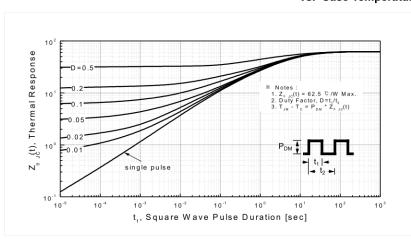
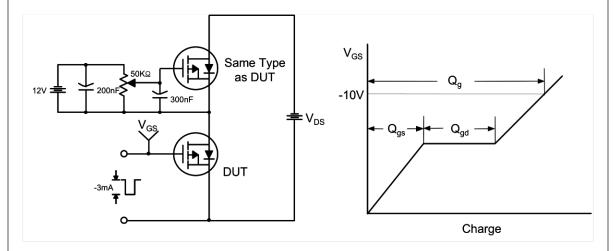
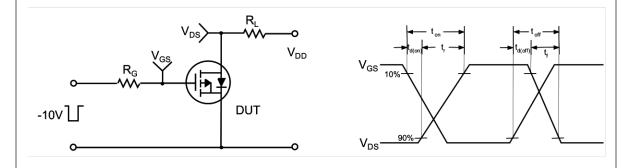


Figure 11. Transient Thermal Response Curve

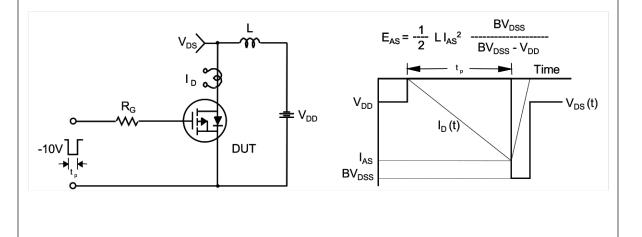
Gate Charge Test Circuit & Waveform



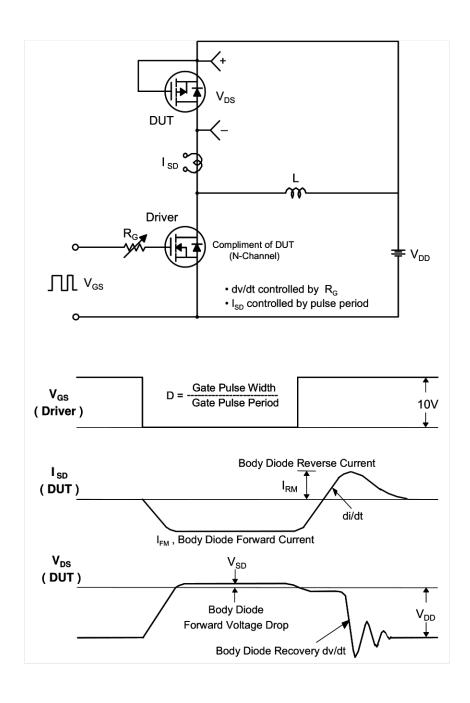
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms



Peak Diode Recovery dv/dt Test Circuit & Waveforms



Package Dimensions SOT-223 0.65 ±0.20 3.00 ±0.10 MAX1.80 1.75 ±0.20 (0.60)3.50 ±0.20 $0.06^{\,+0.04}_{\,-0.02}$ 7.00 ±0.30 (0.60)2.30 TYP 0°~10° 0.70 ±0.10 $0.25\,^{+0.10}_{-0.05}$ (0.95)(0.95) 4.60 ± 0.25 1.60 ±0.20 6.50 ±0.20 (0.46)(0.89)Dimensions in Millimeters





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